

## EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	1	((multichip adj module) and (lead adj frame) and (semiconductor adj chips) and (bonding adj pads) and (fastening adj device) and wafer).clm.	US-PGPUB	OR	OFF	2007/05/17 09:42

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